


- ① Substrate: 1.59mm \pm 0.18mm [0.0625" \pm 0.007"] FR4/G10 or equivalent high temp material. 17 μ m [1/2 oz.] Cu clad. SnPb plating.
- ④ Leads: material- BeCu Alloy 194; plating- 60/40 SnPb 3.80-10.16 μ m [150-400 μ "].

Description: Carrier Adapter

32 position PLCC ZIF socket to surface mountable PLCC emulator foot. Two piece adaptor interconnects via a gold plated mini-grid socket interface.

Tolerances: diameters \pm 0.03mm [\pm 0.001"], PCB perimeters \pm 0.13mm [\pm 0.005"], PCB thicknesses \pm 0.18mm [\pm 0.007"], pitches (from true position) \pm 0.08mm [\pm 0.003"], all other tolerances \pm 0.13mm [\pm 0.005"] unless stated otherwise.

CA-PLCC32-Z-J-01 Drawing		Status: Released	Scale 2:1	Rev: A
 <p>© 2002 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com</p>	Drawing: W. Watson		Date: 1/4/02	
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